EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4403	laser with (mark$3 cut$4 etch$4 scrib$3) with (glass ampoule syringe bottle vial)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 10:33
L2	51	1 and laser with puls$5 and (laser beam path) with (deflect$4 mirror reflect$4) and ((mark$3 cut$4 etch$4 scrib$3) near3 (compar$5 reject$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 10:41
L3	36	2 and ((mark$3 cut$4 etch$4 scrib$3) near3 (coat$3 layer$3 deposit$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 10:42
L4	3	3 and ((mark$3 cut$4 etch$4 scrib$3) with transport$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 10:44
L5	11	3 and ((mark$3 cut$4 etch$4 scrib$3) with path)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 10:54
L6	4	2 and ((mark$3 cut$4 etch$4 scrib$3) with path) not 5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:01
L7	11	1 and (mark$3 cut$4 etch$4 scrib$3) same wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:05
L8	55	laser with (mark$3 cut$4 etch$4 scrib$3) same wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:09
L9	30	laser with (mark$3 cut$4 etch$4 scrib$3) with wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:06

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L10	21	laser with (mark$3 etch$4 scrib$3) with wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:07
L11	19	laser with (mark$3 scrib$3) with wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:07
L12	18	laser with mark$3 with wavelength with (nm nanom$5) with "380"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:08
L13	1	11 not 12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:08
L14	10	laser with (mark$3 cut$4 etch$4 scrib$3) same wavelength with (nm nanom$5) with "380" same (glass ampoule syringe bottle vial)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:11
L15	11	laser with (mark$3 cut$4 etch$4 scrib$3) same wavelength with (nm nanom$5) with ("380" "160") same (glass ampoule syringe bottle vial) not 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:12
L16	12	laser with (mark$3 cut$4 etch$4 scrib$3) same wavelength with (nm nanom$5) with ("380" "160" "157") same (glass ampoule syringe bottle vial) not 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:13
L17	1	16 not 15	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:12
L18	2	laser with (mark$3 etch$4 scrib$3) same wavelength with (nm nanom$5) with ("380" "160" "157") with glass	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:14
L19	51	laser with (mark$3 etch$4 scrib$3) with glass and wavelength with (nm nanom$5) with ("380" "160" "157")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:34

L20	4	laser with (mark$3 etch$4 scrib$3) same reject$4 near3 (separat$3 discard$4 remov$4 garbage junk$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:23
L21	0	laser with (mark$3 etch$4 scrib$3) with simultaneous$4 near2 transport$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:34
L22	3	laser with (mark$3 etch$4 scrib$3) with simultaneous$4 with transport$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:35
L23	41	laser with simultaneous$4 with transport$4 and laser with (mark$3 etch$4 scrib$3 cut$4 machining)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:36
L24	2	laser with simultaneous$4 near2 transport$4 and laser with (mark$3 etch$4 scrib$3 cut$4 machining)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:37
L25	220	laser with simultaneous$4 near2 (transport$4 mov$5 motion) and laser with (mark$3 etch$4 scrib$3 cut$4 machining) not 24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:38
L26	148	laser with simultaneous$4 near (transport$4 mov$5 motion) and laser with (mark$3 etch$4 scrib$3 cut$4 machining) not 24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:54
L27	1114	laser with (mark$3 etch$4 scrib$3 cut$4 machining) same ccd	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:55
L28	41	laser with (mark$3 etch$4 scrib$3 cut$4 machining) same ccd with scatter$4 near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 11:56
L29	11	laser with (mark$3 etch$4 scrib$3 cut$4 machining) same ccd near3 detect$4 with scatter$4 near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:00

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L30	0	laser with (mark$3 etch$4 scrib$3 cut$4 machining) same ccd near3 (detect$4 monitor$4) near4 (back rear opposite backside) near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:01
L31	11	laser with (mark$3 etch$4 scrib$3 cut$4 machining) and ccd near3 (detect$4 monitor$4) near4 (back rear opposite backside) near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:04
L32	0	laser with (mark$3 etch$4 scrib$3 cut$4 machining) and camera near3 (detect$4 monitor$4) near4 (back rear opposite backside) near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:04
L33	0	laser with (mark$3 etch$4 scrib$3 cut$4 machining) and (camera video vision) near3 (detect$4 monitor$4) near4 (back rear opposite backside) near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:05
L34	7	laser with (mark$3 etch$4 scrib$3 cut$4 machining) and (camera video vision) with (detect$4 monitor$4) near4 (back rear opposite backside) near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:08
L35	40	laser with (mark$3 etch$4 scrib$3 cut$4 machining) and (camera video vision) with (detect$4 monitor$4) near4 through$3 near2 light	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/06 12:08